

# FDMS039N08B N-Channel PowerTrench<sup>®</sup> MOSFET 80 V, 100 A, 3.9 mΩ

## Features

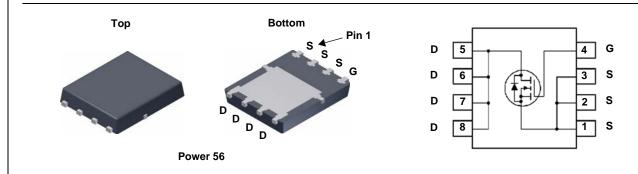
- $R_{DS(on)} = 3.2 \text{ m}\Omega \text{ (Typ.)} @ V_{GS} = 10 \text{ V}, I_D = 50 \text{ A}$
- Low FOM R<sub>DS(on)</sub> \*Q<sub>G</sub>
- Low Reverse Recovery Charge, Q<sub>rr =</sub> 80nC
- Soft Reverse Recovery Body Diode
- Enables Highly Efficiency in Synchronous Rectification
- Fast Switching Speed
- 100% UIL Tested
- RoHS Compliant

# Description

This N-Channel MOSFET is produced using Fairchild Semiconductor<sup>®</sup>'s advance PowerTrench<sup>®</sup> process that has been tailored to minimize the on-state resistance while maintaining superior switching performance.

## **Applications**

- Synchronous Rectification for ATX / Server / Telecom PSU
- Battery Protection Circuit
- Motor drives and Uninterruptible Power Supplies



### MOSFET Maximum Ratings T<sub>C</sub> = 25°C unless otherwise noted\*

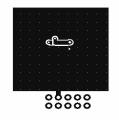
Symbol		FDMS039N08B	Unit			
V <sub>DSS</sub>	Drain to Source Voltage			80	V	
V <sub>GSS</sub>	Gate to Source Voltage			±20	V	
ID	Drain Current	- Continuous (T <sub>C</sub> = 25°C)		100	А	
	Drain Current	- Continuous ( $T_A = 25^{\circ}C$ )	(Note 1)	19.4		
I <sub>DM</sub>	Drain Current	- Pulsed	(Note 2)	400	А	
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 3)			240	mJ	
P <sub>D</sub>	Dower Dissinction	(T <sub>C</sub> = 25°C)		104	W	
	Power Dissipation	$(T_{A} = 25^{\circ}C)$	(Note 1)	2.5	W	
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range			-55 to +150	°C	

# **Thermal Characteristics**

Symbol	Parameter	FDMS039N08B	Unit	
$R_{ ext{ heta}JC}$	Thermal Resistance, Junction to Case, Max.	1.2	°C/W	
$R_{\thetaJA}$	Thermal Resistance, Junction to Ambient, Max. (Note 1)	50	°C/W	

March 2013

Device Marking Device P		Packa	ige	Reel Size	Таре	e Width		Quantit	у	
FDMS039	FDMS039N08B FDMS039N08B Power		r 56 13 " 1		12	2 mm		3000 units		
Electrica	l Char	acteristics T <sub>c</sub> =	25ºC unless	s otherwise	e noted					
Symbol		Parameter		Test Conditions			Min.	Тур.	Max.	Unit
Off Charac	teristic	S								
BV <sub>DSS</sub>	Drain to	to Source Breakdown Voltage		$I_{D} = 250 \mu A, V_{GS} = 0 V$			80	-	-	V
$\Delta BV_{DSS}$ $\Delta T_J$		Breakdown Voltage Temperature Coefficient		$I_D = 250\mu$ A, Referenced to $25^{\circ}$ C			-	0.04	-	V/°C
I <sub>DSS</sub>		o Gate Voltage Drain Current		$V_{DS} = 64V, V_{GS} = 0V$			-	-	1	μA
I <sub>GSS</sub>	Gate to	Body Leakage Currer	nt		20V, V <sub>DS</sub> = 0V		-	-	±100	nA
On Charac				00	/ 03					
V <sub>GS(th)</sub>		Gate Threshold Voltage			V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250μA			_	4.5	V
R <sub>DS(on)</sub>		Drain to Source On Resistance		$V_{GS} = 10V, I_D = 50A$			2.5 -	3.2	3.9	mΩ
9FS	Forwar	ard Transconductance		$V_{DS} = 10V, I_D = 50A$			-	100	-	S
	haract	oristics		20						
-	Characteristics						-	5715	7600	pF
C <sub>iss</sub>		ut Capacitance rse Transfer Capacitance		$V_{DS} = 40V, V_{GS} = 0V$ f = 1MHz		_	881	1170	pF	
C <sub>oss</sub> C <sub>rss</sub>						-	15	-	pF	
C <sub>oss</sub> (er)		Releted Output Capacitance		$V_{PQ} = 4$	0V, V <sub>GS</sub> = 0V		-	1646	-	pF
Q <sub>g(tot)</sub>		Gate Charge at 10V to Source Gate Charge Charge Threshold to Plateau		$V_{\rm DS} = 40V, I_{\rm D} = 50A$ $V_{\rm GS} = 0V \text{ to } 10V$		-	77	100	nC	
Q <sub>gs</sub>						-	34	-	nC	
Q <sub>gs2</sub>						-	13	-	nC	
Q <sub>gd</sub>		e to Drain "Miller" Charge			(Note 4)			16	-	nC
Switching	Charac	teristics								
t <sub>d(on)</sub>		Furn-On Delay Time					-	42	94	ns
t <sub>r</sub>				V <sub>DD</sub> = 40V, I <sub>D</sub> = 50A		-	25	60	ns	
t <sub>d(off)</sub>	Turn-Of	f Delay Time		$V_{\text{GS}} = 10V, R_{\text{GEN}} = 4.7\Omega$ (Note 4)			-	48	106	ns
t <sub>f</sub>	Turn-Of	f Fall Time					-	17	44	ns
ESR	Equival	ent Series Resistance		f = 1MH	Z	, ,	-	1.2	-	Ω
Drain-Sou	rce Dio	de Characteristic	S							
I <sub>S</sub>	-	m Continuous Drain to		de Forward	Current		-	-	100	Α
I <sub>SM</sub>	Maximu	Maximum Pulsed Drain to Source Diode Fo			orward Current			-	400	Α
V <sub>SD</sub>	Drain to	Source Diode Forwar	d Voltage	V <sub>GS</sub> = 0V, I <sub>SD</sub> = 50A			-	-	1.3	V
t <sub>rr</sub>	Reverse	e Recovery Time			V, I <sub>SD</sub> = 50A, V <sub>DD</sub> =	= 40V	-	68	-	ns
	-	Recovery Charge		$dI_F/dt = 100A/\mu s$			80	1	nC	



2. Repetitive Rating: Pulse width limited by maximum junction temperature

4. Essentially Independent of Operating Temperature Typical Characteristics

a. 50 °C/W when mounted on a 1 in<sup>2</sup> pad of 2 oz copper.

b. 125 °C/W when mounted on a minimum pad of 2 oz copper.



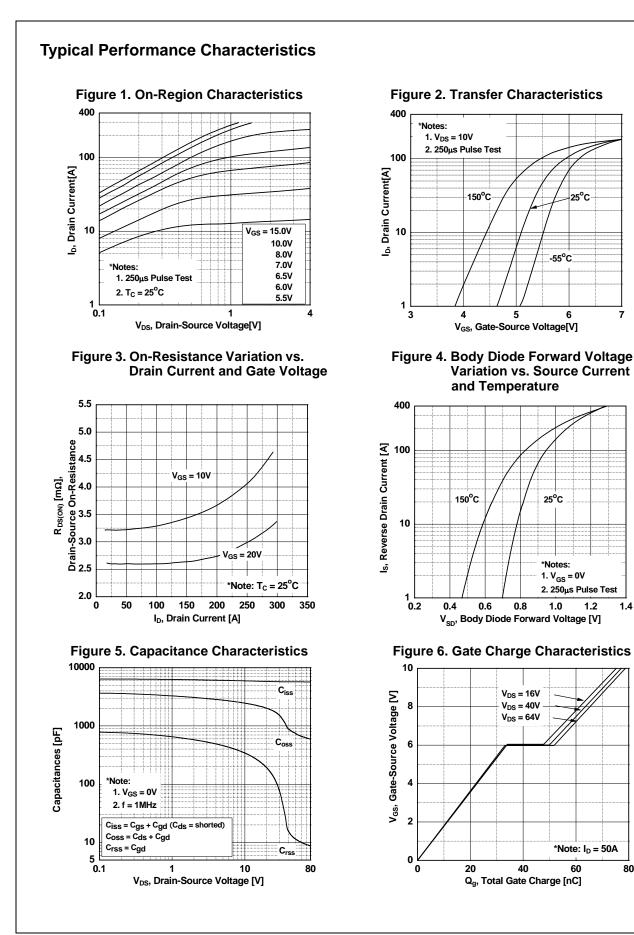
3. L = 0.3mH,  $I_{AS}$  = 40A, Starting  $T_J$  = 25°C

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7

1.2

1.4

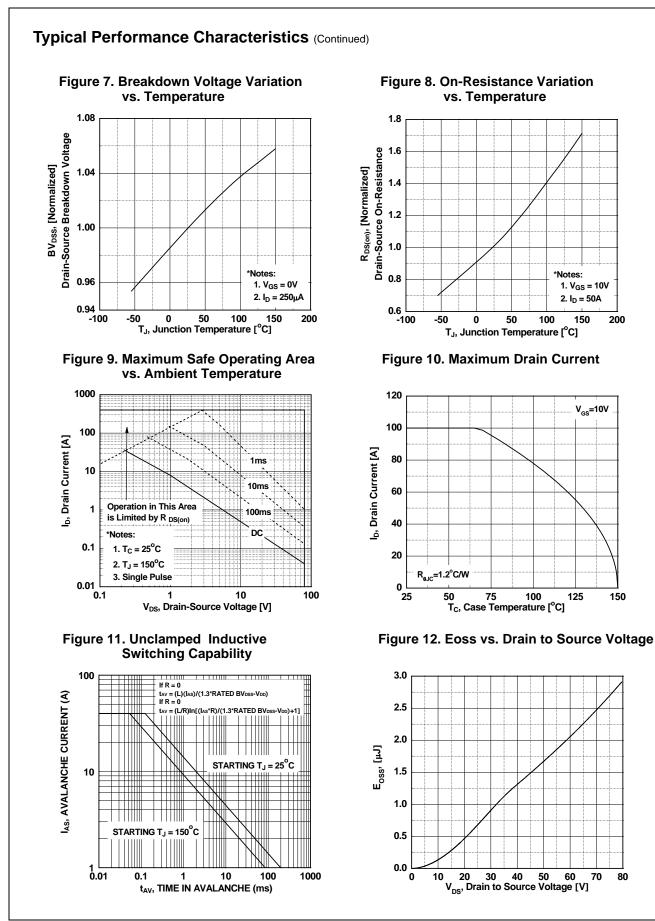


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80

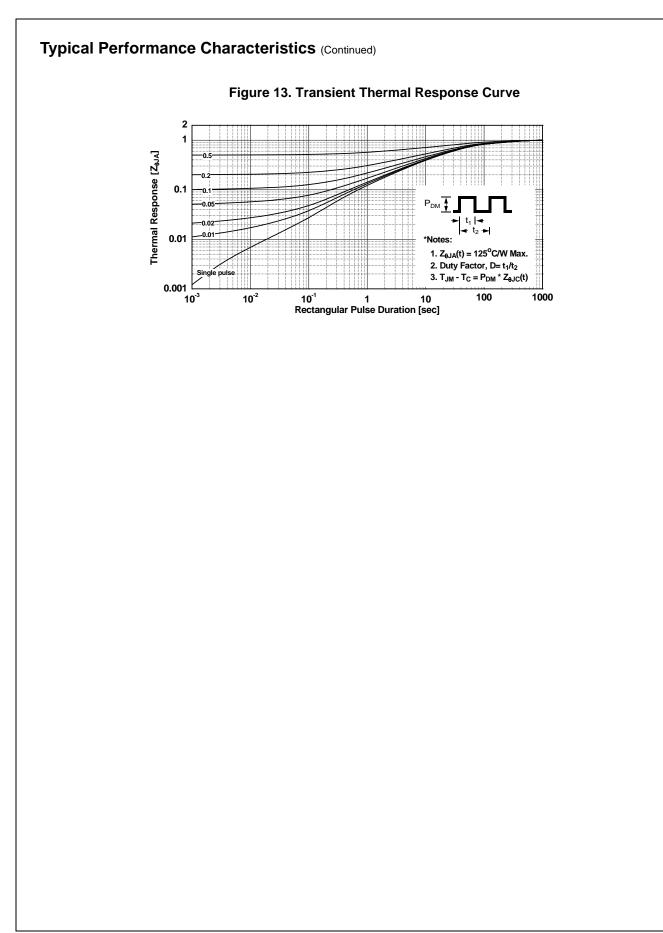
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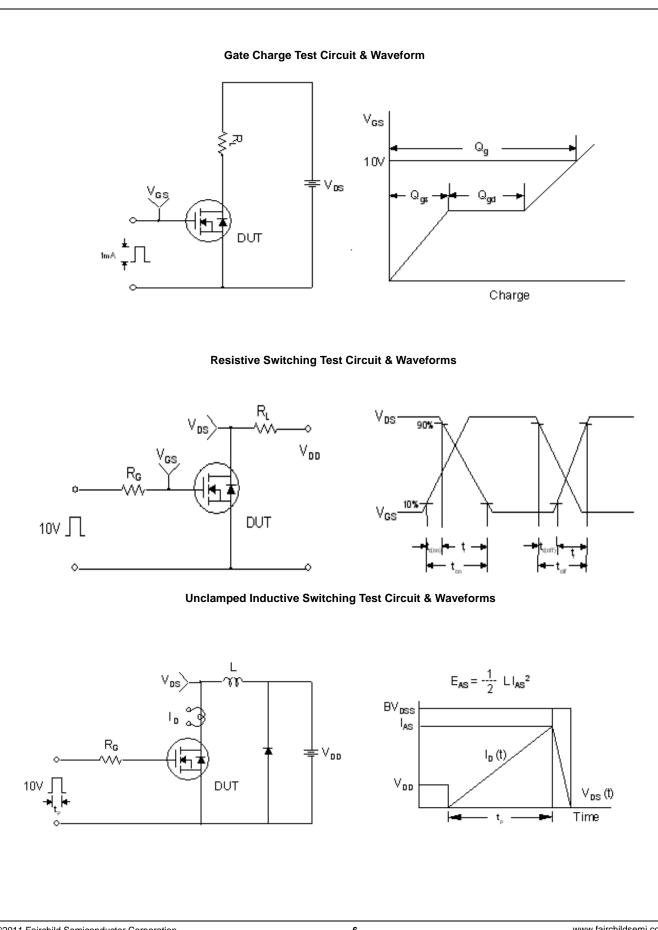
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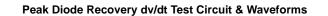
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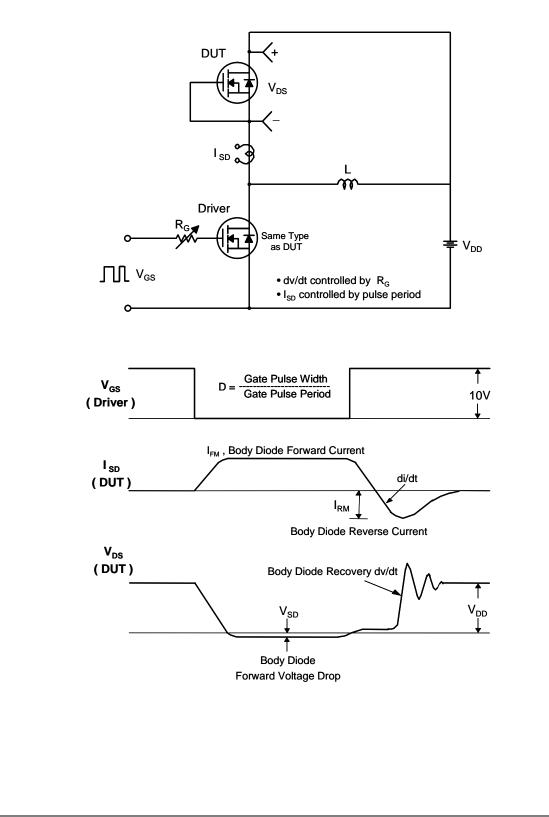
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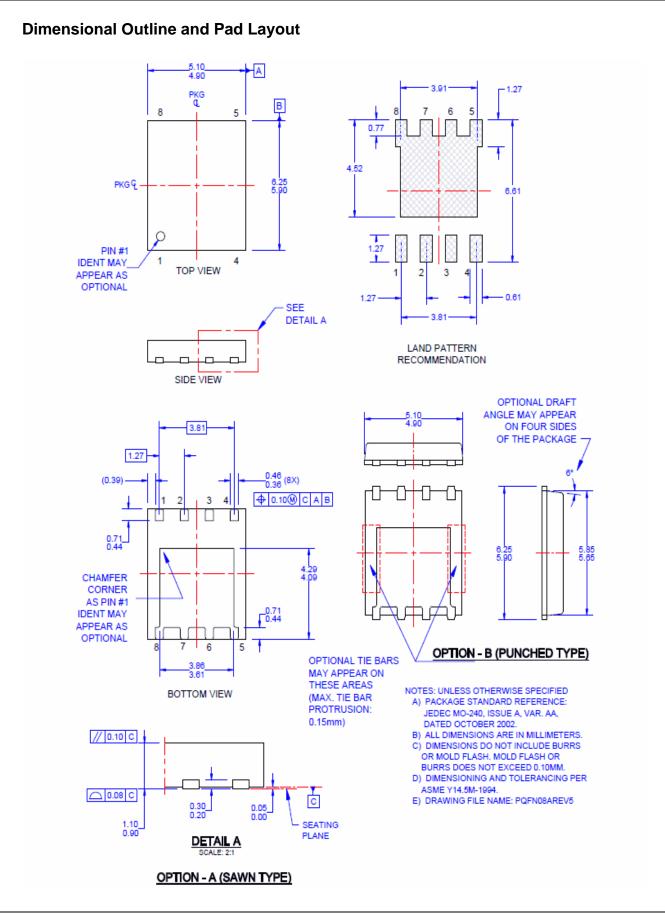




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9